

INTERNATIONAL STANDARD



**Industrial communication networks – Profiles –
Part 2: Additional fieldbus profiles for real-time networks based
on ISO/IEC 8802-3**

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on ISO/IEC 8802-3**

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**INDUSTRIAL COMMUNICATION NETWORKS –
PROFILES –****Part 2: Additional fieldbus profiles for real-time
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FOREWORD

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The main changes with respect to the previous edition are listed below: